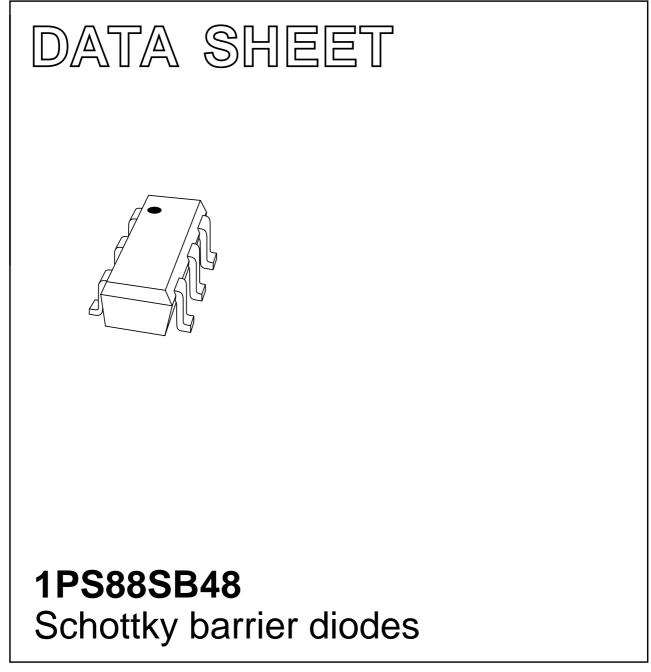
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 Apr 26 2002 Nov 07



FEATURES

- Ultra fast switching speed
- Low forward voltage
- Small SMD package
- · Guard ring protected
- · Low capacitance.

APPLICATIONS

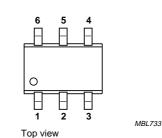
- High speed switching
- Circuit protection
- Voltage clamping.

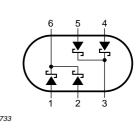
DESCRIPTION

The 1PS88SB48 consists of two dual Schottky barrier diodes with common cathodes, fabricated in planar technology and encapsulated in the small SOT363 SMD plastic package.

PINNING

PIN	DESCRIPTION	
1	anode (a1)	
2	anode (a2)	
3	common cathode (k1)	
4	anode (a3)	
5	anode (a4)	
6	common cathode (k2)	





Marking code: 8t5.

Fig.1 Simplified outline (SOT363; SC-88) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V _R	continuous reverse voltage		-	40	V
I _F	continuous forward current		-	120	mA
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ s}; \delta \le 0.5$	-	120	mA
I _{FSM}	non-repetitive peak forward current	t _p < 10 ms	-	200	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

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ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
Per diode				
V _F	continuous forward voltage	see Fig.2		
		I _F = 1 mA	380	mV
		I _F = 10 mA	500	mV
		I _F = 40 mA	1	V
I _R	continuous reverse current	$V_R = 30$ V; note 1; see Fig.3	1	μA
		$V_R = 40$ V; note 1; see Fig.3	10	μA
C _d	diode capacitance	$V_R = 0$; f = 1 MHz; see Fig.5	5	pF

Note

1. Pulse test: $t_p = 300 \ \mu s$; $\delta = 0.02$.

THERMAL CHARACTERISTICS

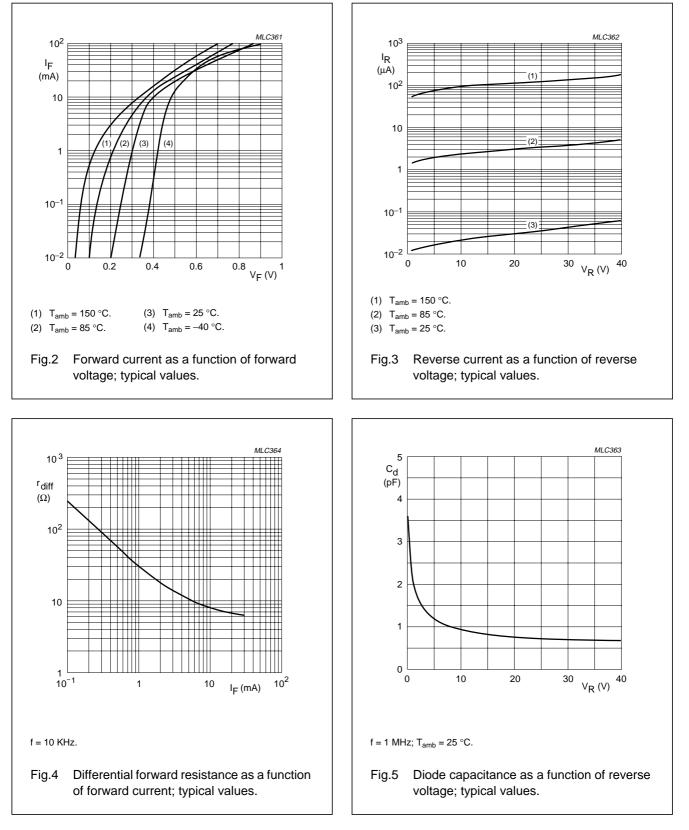
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	416	K/W

Note

1. Refer to SOT363 (SC-88) standard mounting conditions.

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GRAPHICAL DATA

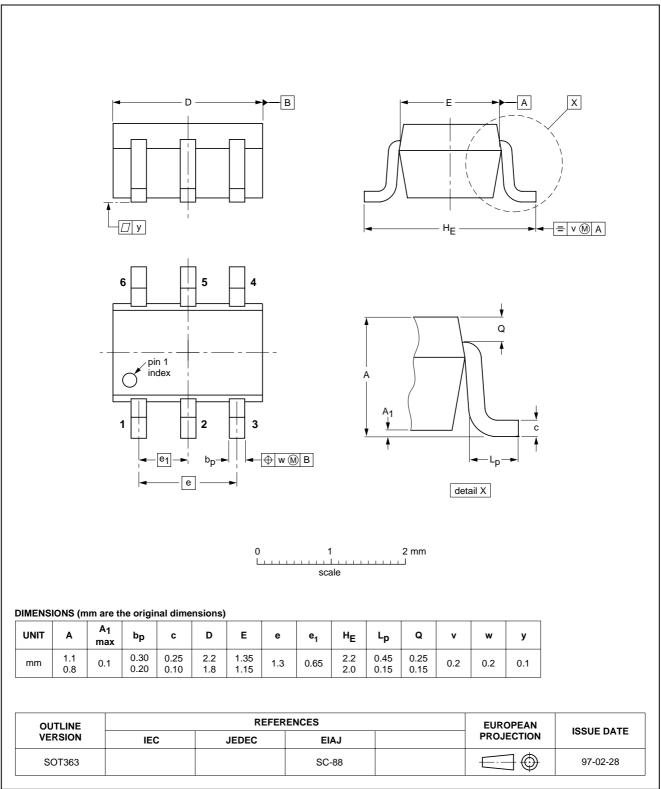


1PS88SB48

Schottky barrier diodes

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads



SOT363

1PS88SB48

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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NOTES

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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